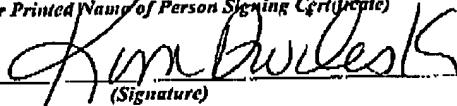


<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>				Docket No. BUR920030026US1
Applicant(s): Gardecki et al.				
Application No. 10/604,164	Filing Date 6/28/2003	Examiner Brook Kebede	Group Art Unit 2823	
Invention: METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS				
<i>RECEIVED CENTRAL FAX CENTER MAY 31 2005</i>				
<p>I hereby certify that this <u>Request for Reconsideration (7 pages)</u> (Identify type of correspondence) is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u> on <u>5/31/2005</u> (Date)</p>				
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Appl. No.: 10/604,164

Applicant(s): Gardecki et al.

MAY 31 2005

Filed.: June 28, 2003

Art Unit: 2823

Dkt. No.: BUR920030026US1

Examiner: Brook Kebode

Title: METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS

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Honorable Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR RECONSIDERATION**

This Request for Reconsideration is being filed in response to the Office Action mailed on May 17, 2005. Applicants request this Amendment be entered in the above-identified application and reconsideration of the application in view of the Amendments and Remarks that follow.

BUR9-2003-0026-US1